

TAIWAN SEMICONDUCTOR MANUFACTURING CO LTD

Form 6-K

September 25, 2009

1934 Act Registration No. 1-14700
SECURITIES AND EXCHANGE COMMISSION
Washington, DC 20549

FORM 6-K

**REPORT OF FOREIGN PRIVATE ISSUER
PURSUANT TO RULE 13a-16 OR 15d-16 OF
THE SECURITIES EXCHANGE ACT OF 1934**

For the month of September 2009

Taiwan Semiconductor Manufacturing Company Ltd.

(Translation of Registrant's Name Into English)

No. 8, Li-Hsin Rd. 6,

Hsinchu Science Park,

Taiwan

(Address of Principal Executive Offices)

(Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.)

Form 20-F

Form 40-F

(Indicate by check mark whether the registrant by furnishing the information contained in this form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.)

Yes

No

(If Yes is marked, indicated below the file number assigned to the registrant in connection with Rule 12g3-2(b):
82: _____.)

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Taiwan Semiconductor Manufacturing Company
Ltd.

Date: September 25, 2009

By /s/ Lora Ho
Lora Ho
Vice President & Chief Financial Officer

Taiwan Semiconductor Manufacturing Company Limited
For the month of August 2009

This is to report 1) the changes in the shareholdings of our directors, executive officers and shareholders who own more than 10% of total outstanding common shares of Taiwan Semiconductor Manufacturing Company Ltd. (The Company; TSMC) (NYSE:TSM); 2) the pledge and clear of pledge of TSMC common shares by our directors, executive officers and shareholders who own more than 10% of total outstanding common shares of TSMC; 3) the acquisition of assets by TSMC and 4) the disposition of assets by TSMC for the month of Aug. 2009.

1) The changes in the shareholdings of our directors, executive officers and shareholders who own more than 10% of total outstanding common shares:

<i>Title</i>	<i>Name</i>	<i>Number of shares held as of July 31, 2009</i>	<i>Number of shares held as of August 31, 2009</i>	<i>Changes</i>
Vice Chairman	F. C. Tseng	35,812,675	35,762,675	-50,000
Director	Rick Tsai	28,356,506	28,166,506	-190,000
Senior Vice President	Stephen T. Tso	15,435,693	15,315,693	-120,000
Senior Vice President	C. C. Wei	8,831,325	8,687,325	-144,000
Senior Vice President	Mark Liu	13,510,573	13,420,573	-90,000
Vice President	Wei-Jen Lo	3,298,127	3,205,127	-93,000
Vice President	Yuan-Chen Sun	5,110,095	4,955,095	-155,000
Vice President	Y. P. Chin	6,336,823	6,296,823	-40,000
Vice President	L.C. Tu	9,316,067	9,315,067	-1,000

2) The pledge and clear of pledge of TSMC common shares by our directors, executive officers and shareholders who own more than 10% of total outstanding common shares:

<i>Title</i>	<i>Name</i>	<i>Number of shares pledged as of July 31, 2009</i>	<i>Number of shares pledged as of August 31, 2009</i>	<i>Changes</i>
Vice President	M. C. Tzeng	2,300,000	1,500,000	-800,000
Vice President & General Counsel	Richard Thurston	460,000	0	-460,000

3) The acquisition of assets:

<i>Description of assets</i>	<i>Purchase price</i>
Manufacturing Equipment	NT\$33,231,936,470
Facility and engineering equipment	NT\$1,029,180,534
Structured Deposit	NT\$2,000,000,000

4) The disposition of assets: None.